

# PBL6005D

60 V PNP BISS loadswitch

Rev. 02 — 7 September 2009

Product data sheet

## 1. Product profile

### 1.1 General description

PNP low  $V_{CEsat}$  Breakthrough In Small Signal (BISS) transistor and NPN Resistor-Equipped Transistor (RET) in a SOT457 (SC-74) small Surface Mounted Device (SMD) plastic package.

### 1.2 Features

- Low  $V_{CEsat}$  (BISS) transistor and resistor-equipped transistor in one package
- Low threshold voltage ( $< 1$  V) compared to MOSFET
- Low drive power required
- Space-saving solution
- Reduction of component count

### 1.3 Applications

- Supply line switches
- Battery charger switches
- High-side switches for LEDs, drivers and backlights
- Portable equipment

### 1.4 Quick reference data

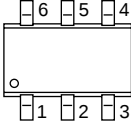
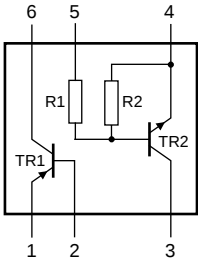
Table 1. Quick reference data

| Symbol                                     | Parameter                               | Conditions                                         | Min   | Typ | Max | Unit |
|--------------------------------------------|-----------------------------------------|----------------------------------------------------|-------|-----|-----|------|
| TR1; PNP low V <sub>CEsat</sub> transistor |                                         |                                                    |       |     |     |      |
| V <sub>CEO</sub>                           | collector-emitter voltage               | open base                                          | -     | -   | −60 | V    |
| I <sub>C</sub>                             | collector current (DC)                  |                                                    | [1] - | -   | −1  | A    |
| R <sub>CEsat</sub>                         | collector-emitter saturation resistance | I <sub>C</sub> = −1 A;<br>I <sub>B</sub> = −100 mA | [2] - | 255 | 340 | mΩ   |
| TR2; NPN resistor-equipped transistor      |                                         |                                                    |       |     |     |      |
| V <sub>CEO</sub>                           | collector-emitter voltage               | open base                                          | -     | -   | 50  | V    |
| I <sub>O</sub>                             | output current (DC)                     |                                                    | -     | -   | 100 | mA   |
| R1                                         | bias resistor 1 (input)                 |                                                    | 33    | 47  | 61  | kΩ   |
| R2/R1                                      | bias resistor ratio                     |                                                    | 0.8   | 1   | 1.2 |      |

[1] Device mounted on a ceramic Printed-Circuit Board (PCB),  $Al_2O_3$ , standard footprint.

[2] Pulse test:  $t_p \leq 300$   $\mu$ s;  $\delta \leq 0.02$

2. Pinning information

| Table 2. Pinning |                        |                                                                                    |                                                                                     |
|------------------|------------------------|------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| Pin              | Description            | Simplified outline                                                                 | Symbol                                                                              |
| 1                | emitter TR1            |  |  |
| 2                | base TR1               |                                                                                    |                                                                                     |
| 3                | output (collector) TR2 |                                                                                    |                                                                                     |
| 4                | GND (emitter) TR2      |                                                                                    |                                                                                     |
| 5                | input (base) TR2       |                                                                                    |                                                                                     |
| 6                | collector TR1          |                                                                                    |                                                                                     |

*sym036*

3. Ordering information

| Table 3. Ordering information |         |                                          |         |
|-------------------------------|---------|------------------------------------------|---------|
| Type number                   | Package |                                          |         |
|                               | Name    | Description                              | Version |
| PBLS6005D                     | SC-74   | plastic surface mounted package; 6 leads | SOT457  |

4. Marking

| Table 4. Marking codes |              |
|------------------------|--------------|
| Type number            | Marking code |
| PBLS6005D              | S5           |

## 5. Limiting values

**Table 5. Limiting values**

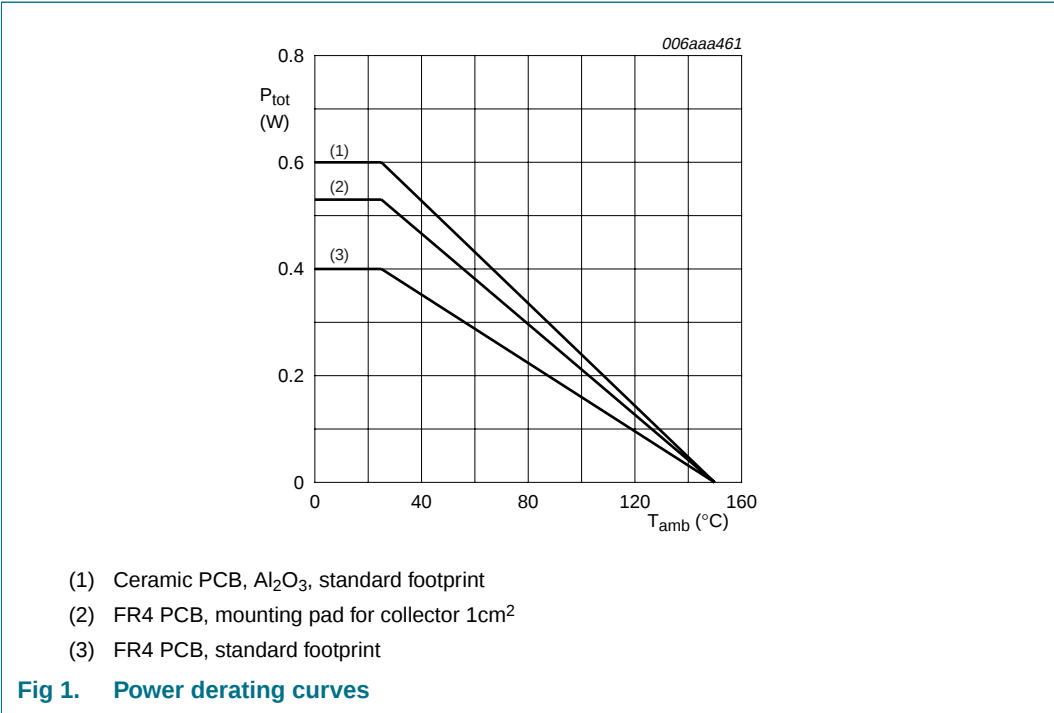
*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol                                | Parameter                 | Conditions                       | Min | Max  | Unit |    |
|---------------------------------------|---------------------------|----------------------------------|-----|------|------|----|
| TR1; PNP low $V_{CEsat}$ transistor   |                           |                                  |     |      |      |    |
| $V_{CBO}$                             | collector-base voltage    | open emitter                     | -   | -80  | V    |    |
| $V_{CEO}$                             | collector-emitter voltage | open base                        | -   | -60  | V    |    |
| $V_{EBO}$                             | emitter-base voltage      | open collector                   | -   | -5   | V    |    |
| $I_C$                                 | collector current (DC)    | [1]                              | -   | -700 | mA   |    |
|                                       |                           | [2]                              | -   | -850 | mA   |    |
|                                       |                           | [3]                              | -   | -1   | A    |    |
| $I_{CM}$                              | peak collector current    | single pulse;<br>$t_p \leq 1$ ms | -   | -2   | A    |    |
| $I_B$                                 | base current (DC)         |                                  | -   | -300 | mA   |    |
| $I_{BM}$                              | peak base current         | single pulse;<br>$t_p \leq 1$ ms | -   | -1   | A    |    |
| $P_{tot}$                             | total power dissipation   | $T_{amb} \leq 25$ °C             | [1] | -    | 250  | mW |
|                                       |                           |                                  | [2] | -    | 350  | mW |
|                                       |                           |                                  | [3] | -    | 400  | mW |
| TR2; NPN resistor-equipped transistor |                           |                                  |     |      |      |    |
| $V_{CBO}$                             | collector-base voltage    | open emitter                     | -   | 50   | V    |    |
| $V_{CEO}$                             | collector-emitter voltage | open base                        | -   | 50   | V    |    |
| $V_{EBO}$                             | emitter-base voltage      | open collector                   | -   | 10   | V    |    |
| $V_I$                                 | input voltage             |                                  |     |      |      |    |
|                                       | positive                  |                                  | -   | +40  | V    |    |
|                                       | negative                  |                                  | -   | -10  | V    |    |
| $I_O$                                 | output current (DC)       |                                  | -   | 100  | mA   |    |
| $I_{CM}$                              | peak collector current    |                                  | -   | 100  | mA   |    |
| $P_{tot}$                             | total power dissipation   | $T_{amb} \leq 25$ °C             | [1] | -    | 200  | mW |
|                                       |                           |                                  | [2] | -    | 200  | mW |
|                                       |                           |                                  | [3] | -    | 200  | mW |
| Per device                            |                           |                                  |     |      |      |    |
| $P_{tot}$                             | total power dissipation   | $T_{amb} \leq 25$ °C             | [1] | -    | 400  | mW |
|                                       |                           |                                  | [2] | -    | 530  | mW |
|                                       |                           |                                  | [3] | -    | 600  | mW |
| $T_{stg}$                             | storage temperature       |                                  | -65 | +150 | °C   |    |
| $T_j$                                 | junction temperature      |                                  | -   | 150  | °C   |    |
| $T_{amb}$                             | ambient temperature       |                                  | -65 | +150 | °C   |    |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1cm<sup>2</sup>.

[3] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.

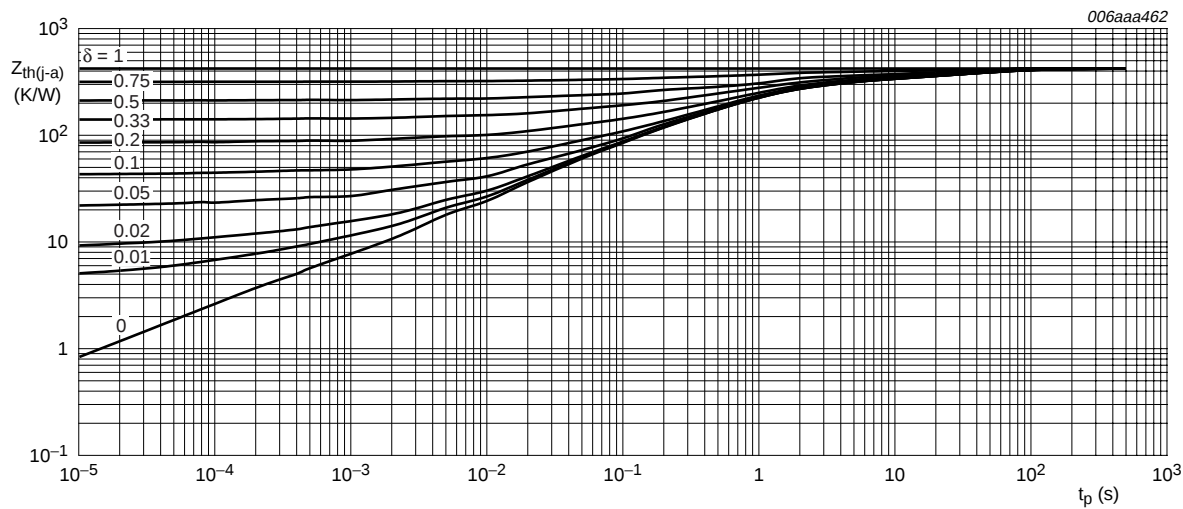


6. Thermal characteristics

Table 6. Thermal characteristics

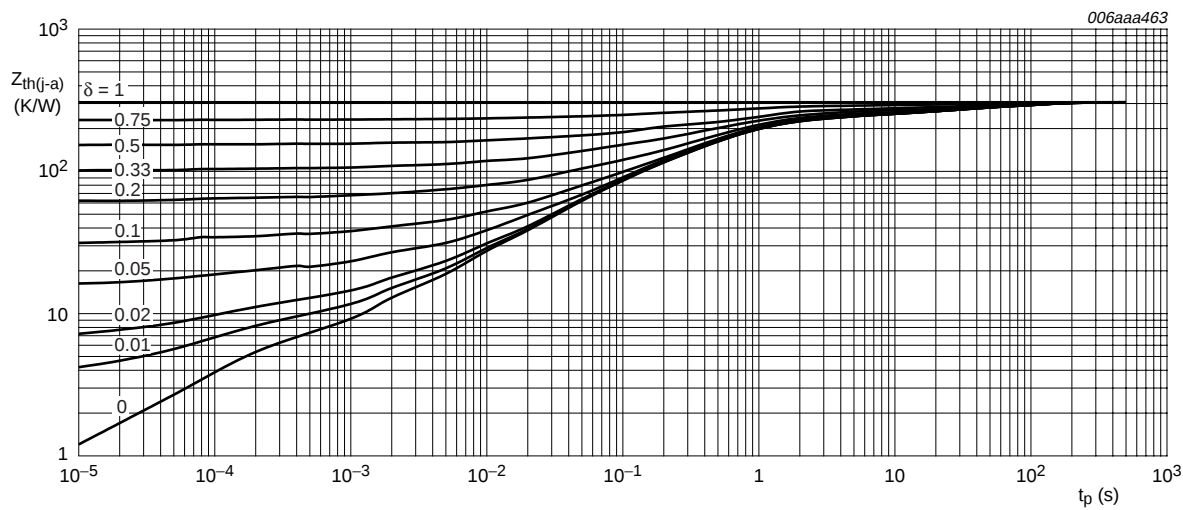
| Symbol                                     | Parameter                                        | Conditions  | Min   | Typ | Max | Unit |
|--------------------------------------------|--------------------------------------------------|-------------|-------|-----|-----|------|
| Per device                                 |                                                  |             |       |     |     |      |
| R <sub>th(j-a)</sub>                       | thermal resistance from junction to ambient      | in free air | [1] - | -   | 312 | K/W  |
|                                            |                                                  |             | [2] - | -   | 236 | K/W  |
|                                            |                                                  |             | [3] - | -   | 208 | K/W  |
| TR1; PNP low V <sub>CEsat</sub> transistor |                                                  |             |       |     |     |      |
| R <sub>th(j-sp)</sub>                      | thermal resistance from junction to solder point |             | -     | -   | 105 | K/W  |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector  $1cm^2$ .  
[3] Device mounted on a ceramic PCB,  $Al_2O_3$ , standard footprint.



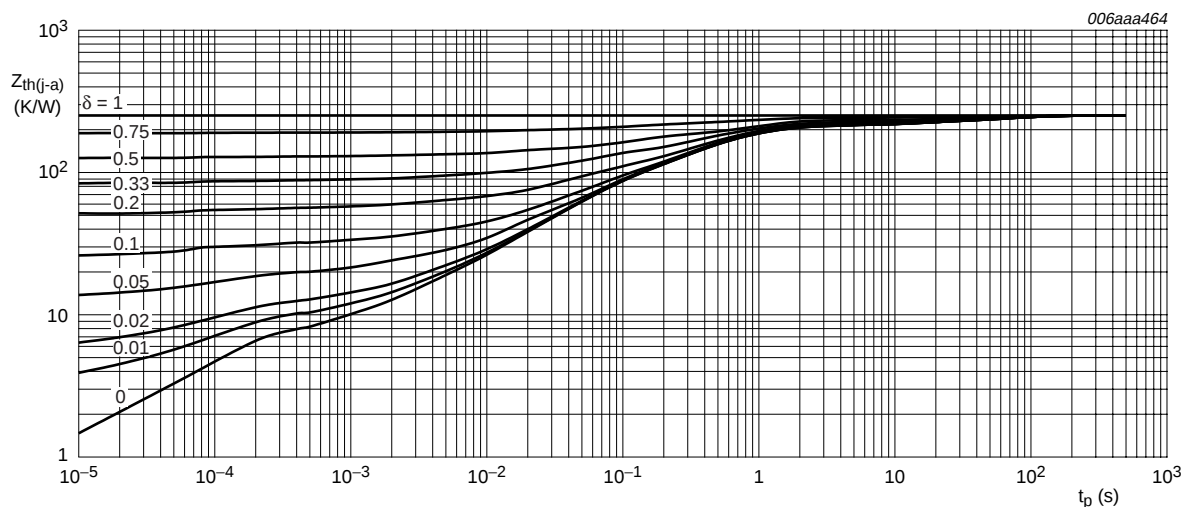
FR4 PCB, standard footprint

Fig 2. TR1 (PNP): Transient thermal impedance from junction to ambient as a function of pulse time; typical values



FR4 PCB, mounting pad for collector 1cm<sup>2</sup>

Fig 3. TR1 (PNP): Transient thermal impedance from junction to ambient as a function of pulse time; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

**Fig 4. TR1 (PNP): Transient thermal impedance from junction to ambient as a function of pulse time; typical values**

## 7. Characteristics

**Table 7. Characteristics**

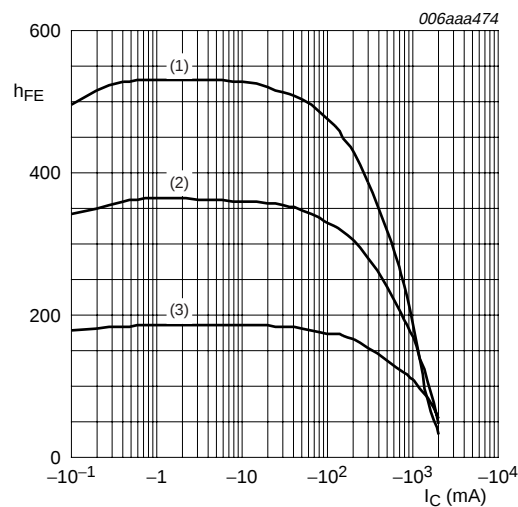
$T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

| Symbol                                                | Parameter                               | Conditions                                                                   | Min     | Typ   | Max  | Unit          |
|-------------------------------------------------------|-----------------------------------------|------------------------------------------------------------------------------|---------|-------|------|---------------|
| <b>TR1; PNP low <math>V_{CEsat}</math> transistor</b> |                                         |                                                                              |         |       |      |               |
| $I_{CBO}$                                             | collector-base cut-off current          | $V_{CB} = -60\text{ V}; I_E = 0\text{ A}$                                    | -       | -     | -100 | nA            |
|                                                       |                                         | $V_{CB} = -60\text{ V}; I_E = 0\text{ A}; T_j = 150\text{ }^{\circ}\text{C}$ | -       | -     | -50  | $\mu\text{A}$ |
| $I_{CES}$                                             | collector-emitter cut-off current       | $V_{CE} = -60\text{ V}; V_{BE} = 0\text{ V}$                                 | -       | -     | -100 | nA            |
| $I_{EBO}$                                             | emitter-base cut-off current            | $V_{EB} = -5\text{ V}; I_C = 0\text{ A}$                                     | -       | -     | -100 | nA            |
| $h_{FE}$                                              | DC current gain                         | $V_{CE} = -5\text{ V}; I_C = -1\text{ mA}$                                   | 200     | 350   | -    |               |
|                                                       |                                         | $V_{CE} = -5\text{ V}; I_C = -500\text{ mA}$                                 | [1] 150 | 230   | -    |               |
|                                                       |                                         | $V_{CE} = -5\text{ V}; I_C = -1000\text{ mA}$                                | [1] 100 | 160   | -    |               |
| $V_{CEsat}$                                           | collector-emitter saturation voltage    | $I_C = -100\text{ mA}; I_B = -1\text{ mA}$                                   | -       | -110  | -175 | mV            |
|                                                       |                                         | $I_C = -500\text{ mA}; I_B = -50\text{ mA}$                                  | [1] -   | -135  | -180 | mV            |
|                                                       |                                         | $I_C = -1000\text{ mA}; I_B = -100\text{ mA}$                                | [1] -   | -255  | -340 | mV            |
| $R_{CEsat}$                                           | collector-emitter saturation resistance | $I_C = -1\text{ A}; I_B = -100\text{ mA}$                                    | [1] -   | 255   | 340  | m $\Omega$    |
| $V_{BEsat}$                                           | base-emitter saturation voltage         | $I_C = -1\text{ A}; I_B = -50\text{ mA}$                                     | [1] -   | -0.95 | -1.1 | V             |

**Table 7. Characteristics ...continued** $T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

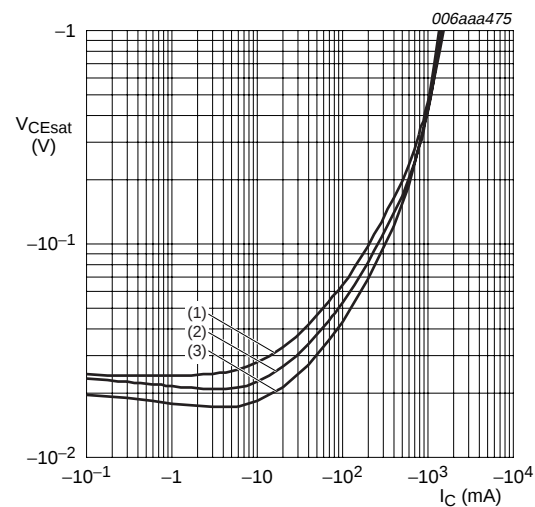
| Symbol                                       | Parameter                            | Conditions                                                                        | Min   | Typ   | Max  | Unit          |
|----------------------------------------------|--------------------------------------|-----------------------------------------------------------------------------------|-------|-------|------|---------------|
| $V_{BEon}$                                   | base-emitter turn-on voltage         | $V_{CE} = -5\text{ V}; I_C = -1\text{ A}$                                         | [1] - | -0.82 | -0.9 | V             |
| $t_d$                                        | delay time                           | $I_C = -0.5\text{ A};$<br>$I_{Bon} = -25\text{ mA};$<br>$I_{Boff} = 25\text{ mA}$ | -     | 11    | -    | ns            |
| $t_r$                                        | rise time                            |                                                                                   | -     | 30    | -    | ns            |
| $t_{on}$                                     | turn-on time                         |                                                                                   | -     | 41    | -    | ns            |
| $t_s$                                        | storage time                         |                                                                                   | -     | 205   | -    | ns            |
| $t_f$                                        | fall time                            |                                                                                   | -     | 55    | -    | ns            |
| $t_{off}$                                    | turn-off time                        |                                                                                   | -     | 260   | -    | ns            |
| $f_T$                                        | transition frequency                 | $I_C = -50\text{ mA};$<br>$V_{CE} = -10\text{ V};$<br>$f = 100\text{ MHz}$        | 150   | 185   | -    | MHz           |
| $C_c$                                        | collector capacitance                | $V_{CB} = -10\text{ V};$<br>$I_E = I_e = 0\text{ A}; f = 1\text{ MHz}$            | -     | 9     | 15   | pF            |
| <b>TR2; NPN resistor-equipped transistor</b> |                                      |                                                                                   |       |       |      |               |
| $I_{CBO}$                                    | collector-base cut-off current       | $V_{CB} = 50\text{ V}; I_E = 0\text{ A}$                                          | -     | -     | 100  | nA            |
| $I_{CEO}$                                    | collector-emitter cut-off current    | $V_{CE} = 30\text{ V}; I_B = 0\text{ A}$                                          | -     | -     | 1    | $\mu\text{A}$ |
|                                              |                                      | $V_{CE} = 30\text{ V}; I_B = 0\text{ A};$<br>$T_j = 150\text{ }^{\circ}\text{C}$  | -     | -     | 50   | $\mu\text{A}$ |
| $I_{EBO}$                                    | emitter-base cut-off current         | $V_{EB} = 5\text{ V}; I_C = 0\text{ A}$                                           | -     | -     | 90   | $\mu\text{A}$ |
| $h_{FE}$                                     | DC current gain                      | $V_{CE} = 5\text{ V}; I_C = 5\text{ mA}$                                          | 80    | -     | -    |               |
| $V_{CEsat}$                                  | collector-emitter saturation voltage | $I_C = 10\text{ mA};$<br>$I_B = 0.5\text{ mA}$                                    | -     | -     | 150  | mV            |
| $V_{I(off)}$                                 | off-state input voltage              | $V_{CE} = 5\text{ V}; I_C = 100\text{ }\mu\text{A}$                               | -     | 1.2   | 0.8  | V             |
| $V_{I(on)}$                                  | on-state input voltage               | $V_{CE} = 0.3\text{ V}; I_C = 2\text{ mA}$                                        | 3.0   | 1.6   | -    | V             |
| R1                                           | bias resistor 1 (input)              |                                                                                   | 33    | 47    | 61   | k $\Omega$    |
| R2/R1                                        | bias resistor ratio                  |                                                                                   | 0.8   | 1     | 1.2  |               |
| $C_c$                                        | collector capacitance                | $V_{CB} = 10\text{ V};$<br>$I_E = I_e = 0\text{ A}; f = 1\text{ MHz}$             | -     | -     | 2.5  | pF            |

[1] Pulse test:  $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02$ .



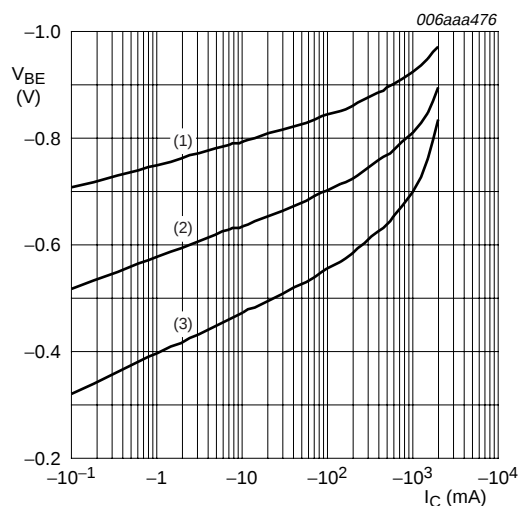
- $V_{CE} = -5\text{ V}$
- (1)  $T_{amb} = 100^\circ\text{C}$
  - (2)  $T_{amb} = 25^\circ\text{C}$
  - (3)  $T_{amb} = -55^\circ\text{C}$

Fig 5. TR1 (PNP): DC current gain as a function of collector current; typical values



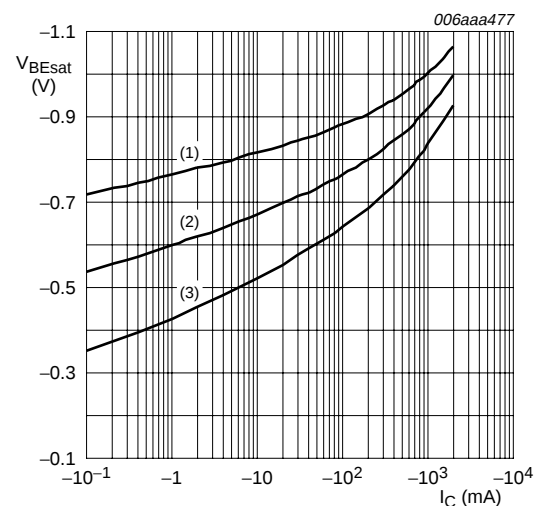
- $I_C/I_B = 20$
- (1)  $T_{amb} = 100^\circ\text{C}$
  - (2)  $T_{amb} = 25^\circ\text{C}$
  - (3)  $T_{amb} = -55^\circ\text{C}$

Fig 6. TR1 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values



- $V_{CE} = -5\text{ V}$
- (1)  $T_{amb} = -55^\circ\text{C}$
  - (2)  $T_{amb} = 25^\circ\text{C}$
  - (3)  $T_{amb} = 100^\circ\text{C}$

Fig 7. TR1 (PNP): Base-emitter voltage as a function of collector current; typical values



- $I_C/I_B = 20$
- (1)  $T_{amb} = -55^\circ\text{C}$
  - (2)  $T_{amb} = 25^\circ\text{C}$
  - (3)  $T_{amb} = 100^\circ\text{C}$

Fig 8. TR1 (PNP): Base-emitter saturation voltage as a function of collector current; typical values

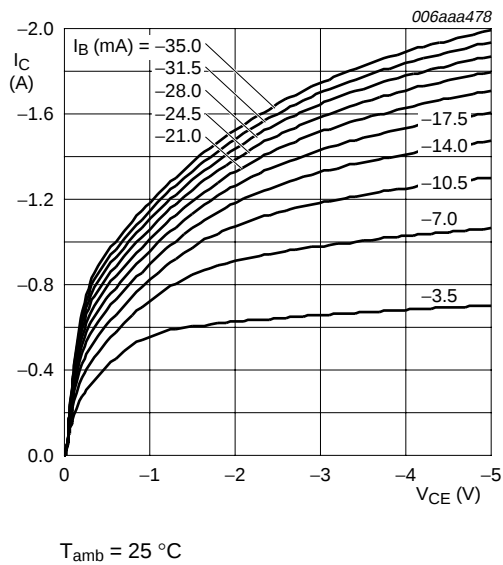


Fig 9. TR1 (PNP): Collector current as a function of collector-emitter voltage; typical values

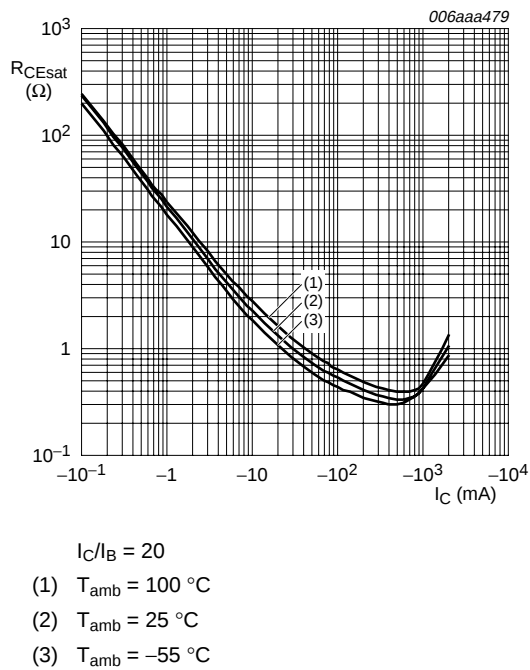


Fig 10. TR1 (PNP): Collector-emitter saturation resistance as a function of collector current; typical values

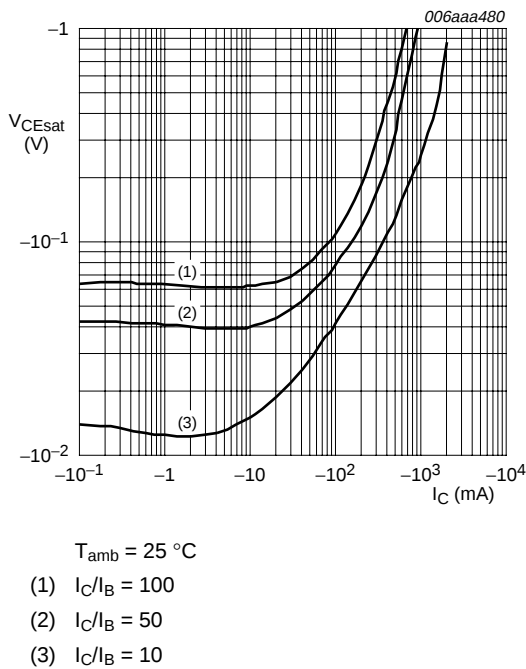


Fig 11. TR1 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values

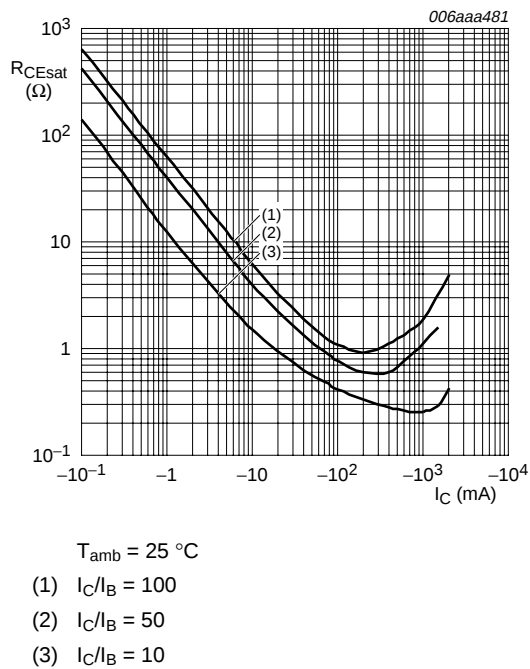
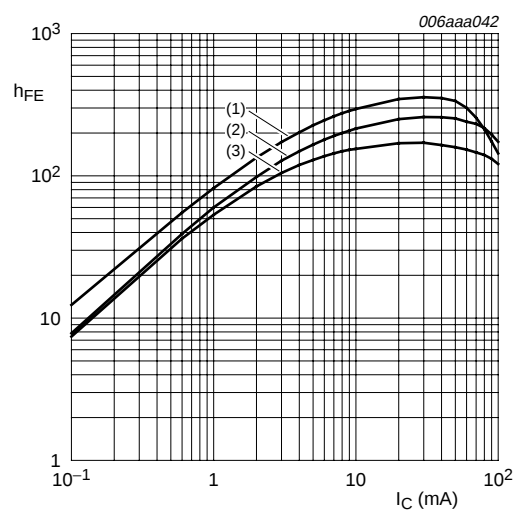
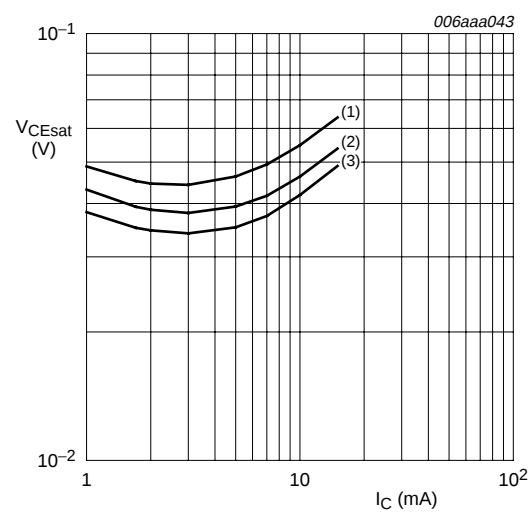


Fig 12. TR1 (PNP): Collector-emitter saturation resistance as a function of collector current; typical values



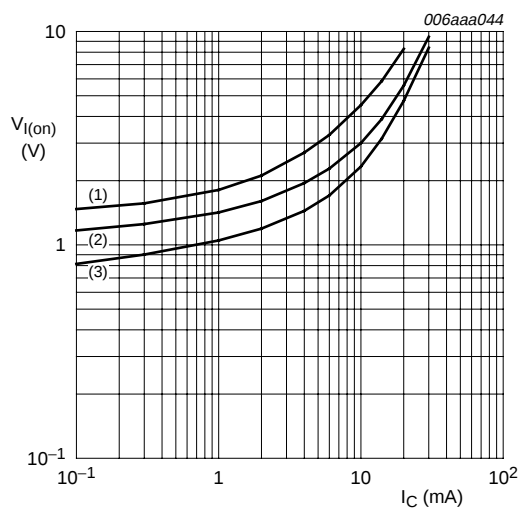
- $V_{CE} = 5\text{ V}$
- (1)  $T_{amb} = 150\text{ }^{\circ}\text{C}$
  - (2)  $T_{amb} = 25\text{ }^{\circ}\text{C}$
  - (3)  $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig 13. TR2 (NPN): DC current gain as a function of collector current; typical values



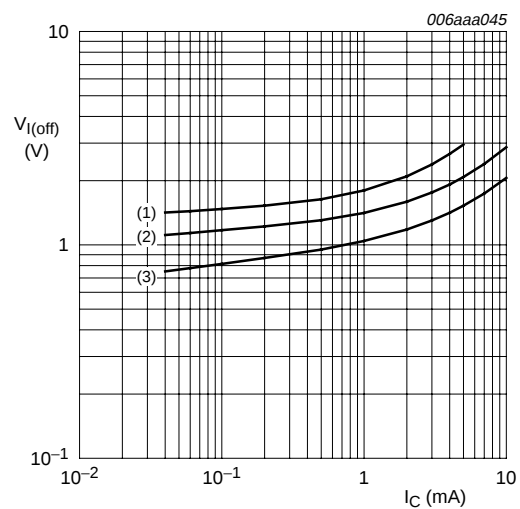
- $I_C/I_B = 20$
- (1)  $T_{amb} = 100\text{ }^{\circ}\text{C}$
  - (2)  $T_{amb} = 25\text{ }^{\circ}\text{C}$
  - (3)  $T_{amb} = -40\text{ }^{\circ}\text{C}$

Fig 14. TR2 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values



- $V_{CE} = 0.3\text{ V}$
- (1)  $T_{amb} = -40\text{ }^{\circ}\text{C}$
  - (2)  $T_{amb} = 25\text{ }^{\circ}\text{C}$
  - (3)  $T_{amb} = 100\text{ }^{\circ}\text{C}$

Fig 15. TR2 (NPN): On-state input voltage as a function of collector current; typical values



- $V_{CE} = 5\text{ V}$
- (1)  $T_{amb} = -40\text{ }^{\circ}\text{C}$
  - (2)  $T_{amb} = 25\text{ }^{\circ}\text{C}$
  - (3)  $T_{amb} = 100\text{ }^{\circ}\text{C}$

Fig 16. TR2 (NPN): Off-state input voltage as a function of collector current; typical values

8. Test information

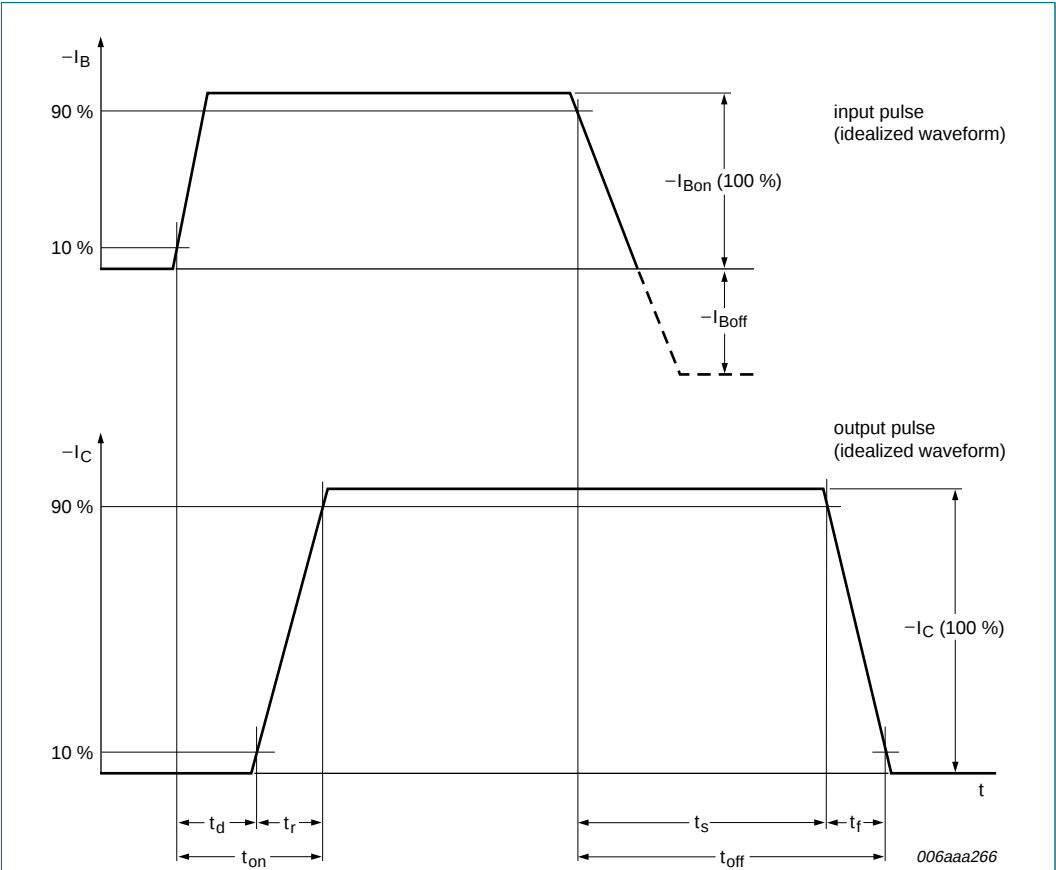
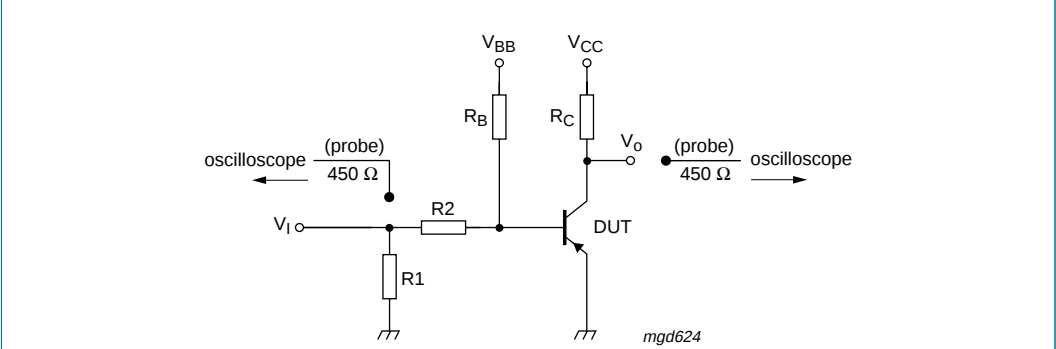


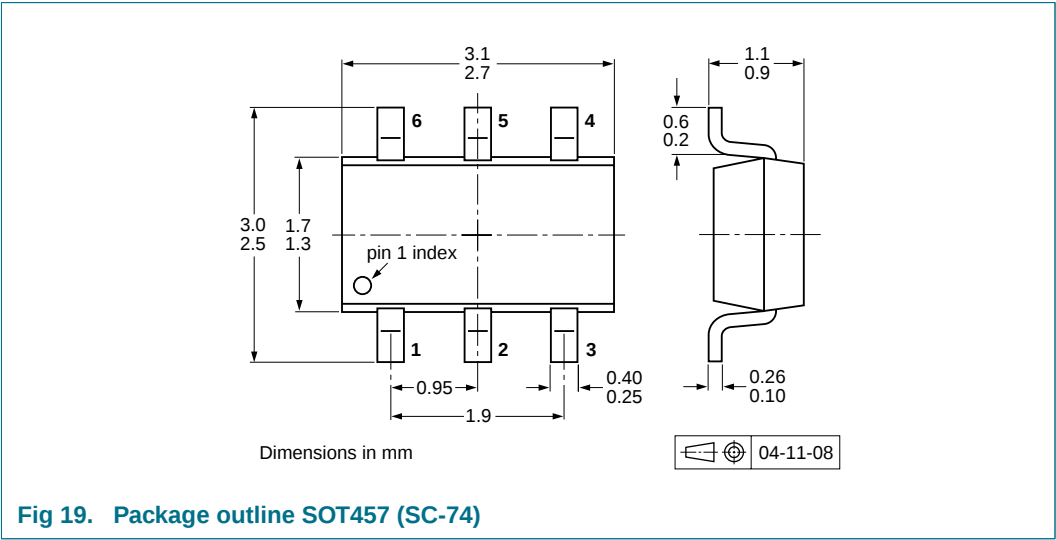
Fig 17. BISS transistor switching time definition



$I_C = -0.5\text{ A}$ ;  $I_{Bon} = -25\text{ mA}$ ;  $I_{Boff} = 25\text{ mA}$ ;  $R_1 = \text{open}$ ;  $R_2 = 100\text{ }\Omega$ ;  $R_B = 300\text{ }\Omega$ ;  $R_C = 20\text{ }\Omega$

Fig 18. Test circuit for switching times

9. Package outline



10. Packing information

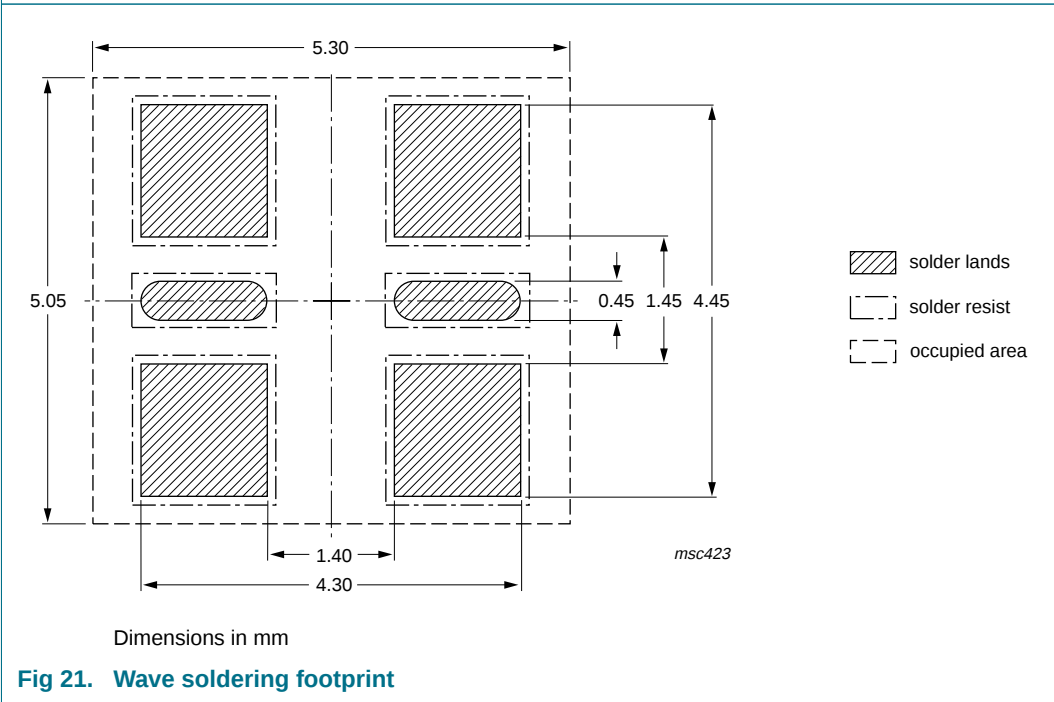
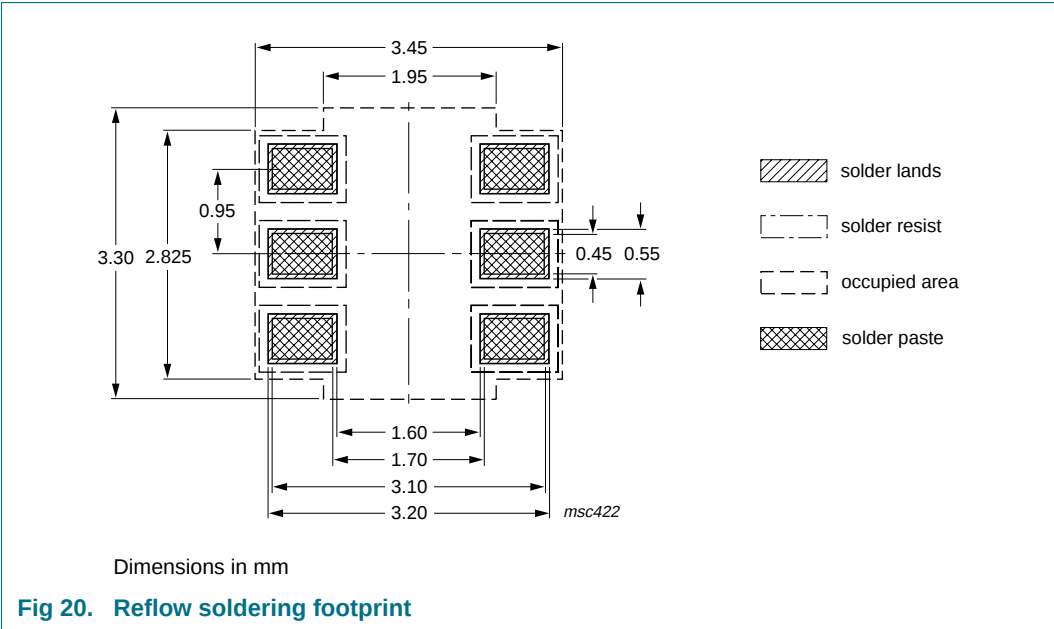
| Type number | Package | Description                                            | Packing quantity |       |
|-------------|---------|--------------------------------------------------------|------------------|-------|
|             |         |                                                        | 3000             | 10000 |
| PBLS6005D   | SOT457  | 4 mm pitch, 8 mm tape and reel; T1 <a href="#">[2]</a> | -115             | -135  |
|             |         | 4 mm pitch, 8 mm tape and reel; T2 <a href="#">[3]</a> | -125             | -165  |

[1] For further information and the availability of packing methods, see [Section 14](#).

[2] T1: normal taping

[3] T2: reverse taping

11. Soldering



## 12. Revision history

Table 9. Revision history

| Document ID    | Release date                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  | Data sheet status  | Change notice | Supersedes |
|----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------|---------------|------------|
| PBL6005D_2     | 20090907                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | Product data sheet | -             | PBL6005D_1 |
| Modifications: | <ul style="list-style-type: none"><li>This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content.</li><li><a href="#">Figure 6 "TR1 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values"</a>: <math>V_{CEsat}</math> unit amended from mV to V</li><li><a href="#">Figure 21 "Wave soldering footprint"</a>: updated</li></ul> |                    |               |            |
| PBL6005D_1     | 20050623                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      | Product data sheet | -             | -          |

## 13. Legal information

### 13.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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